_ AS		Material Compo © Copyright 2005. IPC, Banno ooth international and Pan-Amer	ckburn, Illinois.	All rights reserve	ion with lower	level p	arts, the	declaration	n encompas		r level mater	ials for	which the	item is an assembly manufacturer has eclaration.
		PC Web Site for Informanttp://www.ipc.org/IPC-	Site for Information on IPC-1752 Standard w.ipc.org/IPC-175x					Form Type * Declaration Class *						
Sup	pplier Information													
Company Name *		Company Unique ID	)	Unique ID Authority		Response Date *		*	Res	Response Document ID				
Contact Name *		Title - Contact		Phone - Contact *		Email	Email - Contact *							
Authorized Representative *		e * Title - Representativ	е	Phone - Representative *		Email - Representative		* Sup	plier Comme	ents or URL	for Add	ditional Inf	ormation	
	Requester Item Number	Mfr Item Number		Mfr Item Name		Effective Date \		Version	Manufacturi	ng Site Weight *		UC	OM	Unit Type
Alternate Recommendation		ion					Alternate Item C		Item Comme	Comments				
Ма	nufacturing Process	s Information												
Terminal Plating / Grid Array Mater		laterial	Terminal Ba	se Alloy	J-STD-020 MSL Ra	ting	Peak Proc	ess Body	Temperature C	Max Time a	·	erature conds	Number o	f Reflow Cycles
Con	nments		1							•				

Save the fields i this form to a file			Locked
RoHS Materia	l Composition Declaration	Declaration Type	*
	<b>RoHS Definition:</b> Quantity limit of 0.1% by mass (1000 PPM) in homogened Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass		ominated Biphenyls (PBB),
RoHS Declaration	on *	Supplier Acceptance *	
•	e declared item does not contain RoHS restricted substances per the definition abo all applicable exemptions.	we except for defined RoHS exemptions, then select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature		
	omplete all of the required fields on all pages of this form. Select the "According frequired by the Requester) and click on Submit Form to have the form return.		e signature area. Digitally sigr
Supplier Digital S	Signature		

## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem	Homogeneous W U		Unit of Measure	Lovel	Substance Category	Cubatanaa	CAS	Exempt	Walakt	Unit of	Tolerance		PPM
Name	Homogeneous Material	weight	Measure	Level	Substance Category	Substance	CAS	Exempt	vveignt	Measure	-	+	PPIVI
1													
												-	
												-	
												-	
		I											<u> </u>
													<u> </u>
												_	
		ı	T T										
													1